

L Number	Hits	Search Text	DB	Tim stamp
1	351	438/404,407.ccls.	USPAT	2003/03/24 14:17
2	352	438/423,439.ccls.	USPAT	2003/03/24 14:17
3	194	438/440,449.ccls.	USPAT	2003/03/24 14:17
4	166	438/451,480.ccls.	USPAT	2003/03/24 14:18
5	625	438/766,769,770.ccls.	USPAT	2003/03/24 14:21
6	1028	257/347.ccls.	USPAT	2003/03/24 14:22
7	5194	(implant\$6 same oxygen) and substrate	USPAT	2003/03/24 14:25
8	3282	((implant\$6 same oxygen) and substrate) and ("SOI" (silicon same insulat\$6))	USPAT	2003/03/24 14:25
9	1351	((implant\$6 same oxygen) and substrate) and ("SOI" (silicon same insulat\$6))) and (implant\$6 adj2 oxygen)	USPAT	2003/03/24 14:24
10	2017	(implant\$6 same oxygen) and substrate	EPO; JPO; DERWENT; IBM_TDB	2003/03/24 14:25
11	539	((implant\$6 same oxygen) and substrate) and ("SOI" (silicon same insulat\$6))	EPO; JPO; DERWENT; IBM_TDB	2003/03/24 14:25
12	902	(implant\$6 same oxygen) and substrate	US-PGPUB	2003/03/24 14:25
13	594	((implant\$6 same oxygen) and substrate) and ("SOI" (silicon same insulat\$6))	US-PGPUB	2003/03/24 14:26
14	6	jang-tae\$.in.	US-PGPUB	2003/03/24 14:26
15	14	jang-tae\$.in.	EPO; JPO; DERWENT; IBM_TDB	2003/03/24 14:26
16	34	jang-tae\$.in.	USPAT	2003/03/24 14:26